FAIRCHILD
SEMICONDUCTOR®

HGTP14N36G3VL, HGT1S14N36G3VL, HGT1S14N36G3VLS

14A, 360V N-Channel, Logic Level, Voltage Clamping IGBTs

December 2001

Features

- **Logic Level Gate Drive**
- **Internal Voltage Clamp**
- **ESD Gate Protection**
- **$T_J = 175^oC$**
- **Ignition Energy Capable**

Description

This N-Channel IGBT is a MOS gated, logic level device which is intended to be used as an ignition coil driver in automotive ignition circuits. Unique features include an active voltage clamp between the collector and the gate which provides Self Clamped Inductive Switching (SCIS) capability in ignition circuits. Internal diodes provide ESD protection for the logic level gate. Both a series resistor and a shunt resister are provided in the gate circuit.

PACKAGING AVAILABILITY

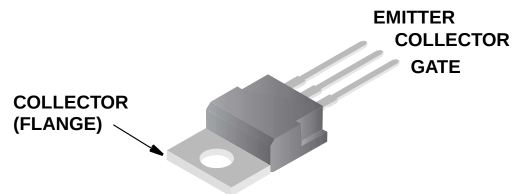
PART NUMBER	PACKAGE	BRAND
HGTP14N36G3VL	TO-220AB	14N36GVL
HGT1S14N36G3VL	TO-262AA	14N36GVL
HGT1S14N36G3VLS	TO-263AB	14N36GVL

NOTE: When ordering, use the entire part number. Add the suffix 9A to obtain the TO-263AB variant in the tape and reel, i.e., HGT1S14N36G3VLS9A.

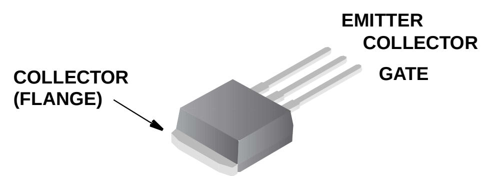
The development type number for this device is TA49021.

Packages

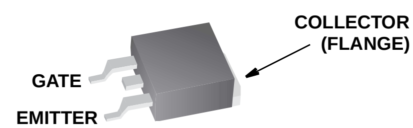
JEDEC TO-220AB



JEDEC TO-262AA

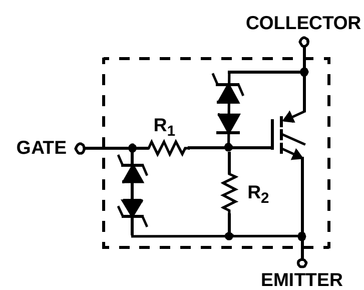


JEDEC TO-263AB



Terminal Diagram

N-CHANNEL ENHANCEMENT MODE



Absolute Maximum Ratings $T_C = +25^oC$, Unless Otherwise Specified

		HGTP14N36G3VL, HGT1S14N36G3VL, HGT1S14N36G3VLS	UNITS
Collector-Emitter Bkdn Voltage at 10mA	BV_{CER}	390	V
Emitter-Collector Bkdn Voltage at 10mA	BV_{ECS}	24	V
Collector Current Continuous at $V_{GE} = 5V$, $T_C = +25^oC$	I_{C25}	18	A
at $V_{GE} = 5V$, $T_C = +100^oC$	I_{C100}	14	A
Gate-Emitter Voltage (Note)	V_{GEM}	±10	V
Inductive Switching Current at L = 2.3mH, $T_C = +25^oC$	I_{SCIS}	17	A
at L = 2.3mH, $T_C = +175^oC$	I_{SCIS}	12	A
Collector to Emitter Avalanche Energy at L = 2.3mH, $T_C = +25^oC$	E_{AS}	332	mJ
Power Dissipation Total at $T_C = +25^oC$	P_D	100	W
Power Dissipation Derating $T_C > +25^oC$		0.67	$W/^oC$
Operating and Storage Junction Temperature Range	T_J, T_{STG}	-40 to +175	^oC
Maximum Lead Temperature for Soldering	T_L	260	^oC
Electrostatic Voltage at 100pF, 1500Ω	ESD	6	KV

NOTE: May be exceeded if I_{GEM} is limited to 10mA.

Electrical Specifications $T_C = +25^oC$, Unless Otherwise Specified

PARAMETERS	SYMBOL	TEST CONDITIONS		LIMITS MIN	TYP	MAX	UNITS
Collector-Emitter Breakdown Voltage	BV_{CER}	$I_C = 10mA$, $V_{GE} = 0V$ $R_{GE} = 1k\Omega$	$T_C = +175^oC$	320	355	400	V
			$T_C = +25^oC$	330	360	390	V
			$T_C = -40^oC$	320	350	385	V
Gate-Emitter Plateau Voltage	V_{GEP}	$I_C = 7A$, $V_{CE} = 12V$	$T_C = +25^oC$	-	2.7	-	V
Gate Charge	$Q_{G(ON)}$	$I_C = 7A$, $V_{CE} = 12V$	$T_C = +25^oC$	-	24	-	nC
Collector-Emitter Clamp Breakdown Voltage	$BV_{CE(CL)}$	$I_C = 7A$ $R_G = 1000\Omega$	$T_C = +175^oC$	350	380	410	V
Emitter-Collector Breakdown Voltage	BV_{ECS}	$I_C = 10mA$	$T_C = +25^oC$	24	28	-	V
Collector-Emitter Leakage Current	I_{CER}	$V_{CE} = 250V$ $R_{GE} = 1k\Omega$	$T_C = +25^oC$	-	-	25	μA
			$T_C = +175^oC$	-	-	250	μA
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	$I_C = 7A$ $V_{GE} = 4.5V$	$T_C = +25^oC$	-	1.25	1.45	V
			$T_C = +175^oC$	-	1.15	1.6	V
		$I_C = 14A$ $V_{GE} = 5V$	$T_C = +25^oC$	-	1.6	2.2	V
			$T_C = +175^oC$	-	1.7	2.9	V
Gate-Emitter Threshold Voltage	$V_{GE(TH)}$	$I_C = 1mA$ $V_{CE} = V_{GE}$	$T_C = +25^oC$	1.3	1.8	2.2	V
Gate Series Resistance	R_1		$T_C = +25^oC$	-	75	-	Ω
Gate-Emitter Resistance	R_2		$T_C = +25^oC$	10	20	30	kΩ
Gate-Emitter Leakage Current	I_{GES}	$V_{GE} = \pm10V$		±330	±500	±1000	μA
Gate-Emitter Breakdown Voltage	BV_{GES}	$I_{GES} = \pm2mA$		±12	±14	-	V
Current Turn-Off Time-Inductive Load	$t_{D(OFF)I}$ + $t_{F(OFF)I}$	$I_C = 7A$, $R_L = 28\Omega$ $R_G = 25\Omega$, $L = 550\mu H$, $V_{CL} = 300V$, $V_{GE} = 5V$, $T_C = +175^oC$		-	7	-	μs
Inductive Use Test	I_{SCIS}	$L = 2.3mH$, $V_G = 5V$,	$T_C = +175^oC$	12	-	-	A
			$T_C = +25^oC$	17	-	-	A
Thermal Resistance	$R_{\theta JC}$			-	-	1.5	$^oC/W$

Typical Performance Curves

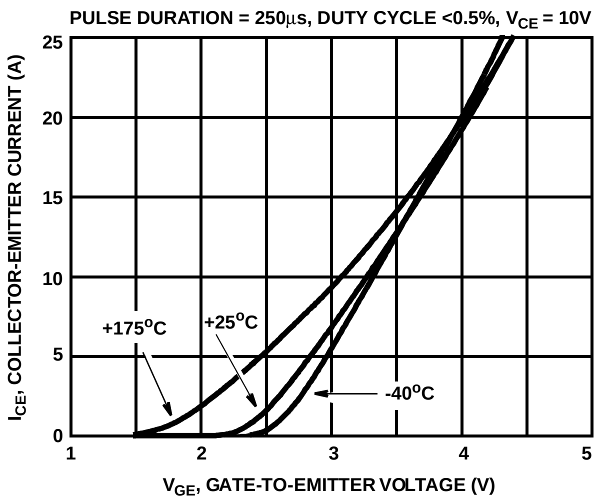


FIGURE 1. TRANSFER CHARACTERISTICS

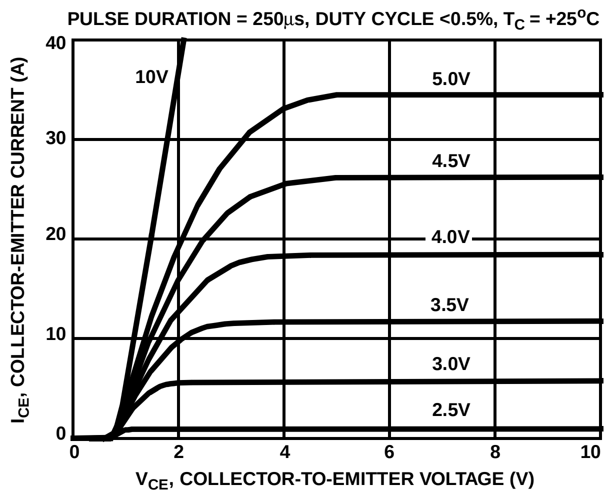


FIGURE 2. SATURATION CHARACTERISTICS

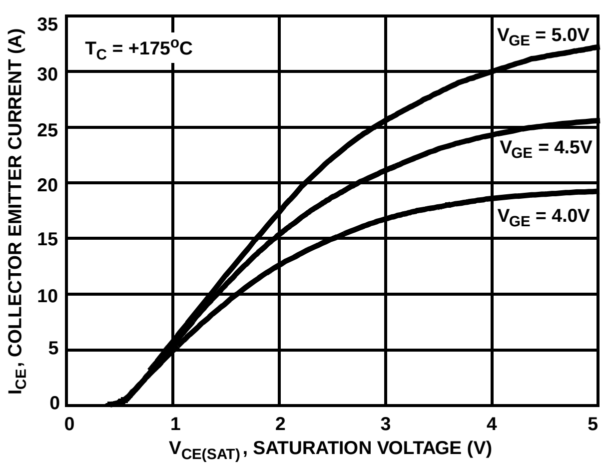


FIGURE 3. COLLECTOR-EMITTER CURRENT AS A FUNCTION OF SATURATION VOLTAGE

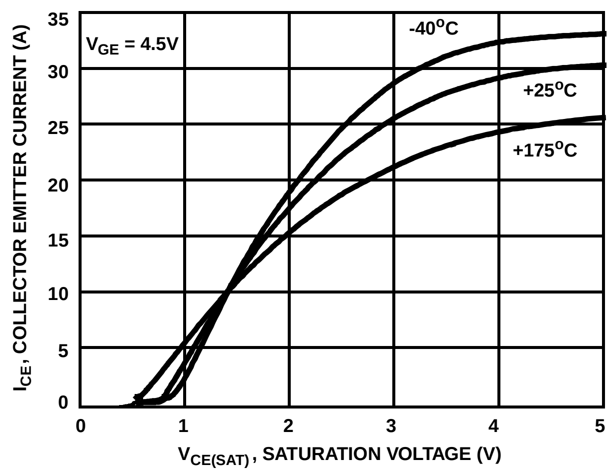


FIGURE 4. COLLECTOR-EMITTER CURRENT AS A FUNCTION OF SATURATION VOLTAGE

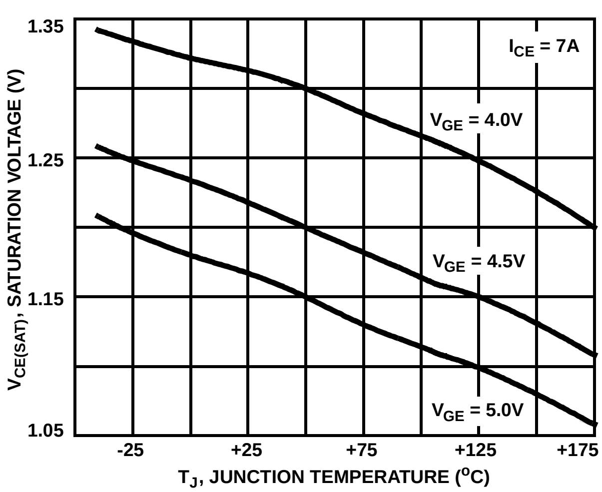


FIGURE 5. SATURATION VOLTAGE AS A FUNCTION OF JUNCTION TEMPERATURE

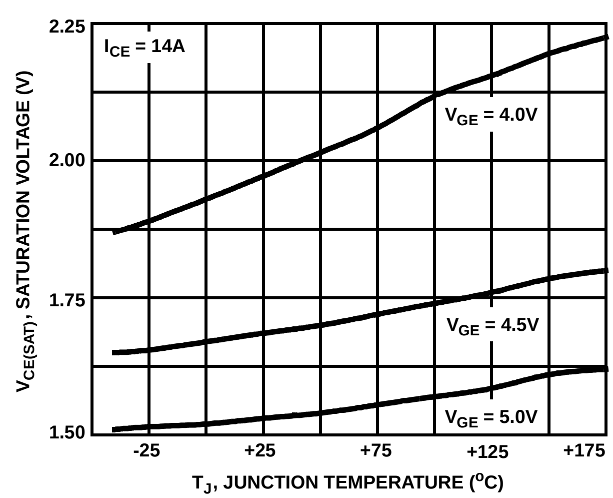


FIGURE 6. SATURATION VOLTAGE AS A FUNCTION OF JUNCTION TEMPERATURE

Typical Performance Curves (Continued)

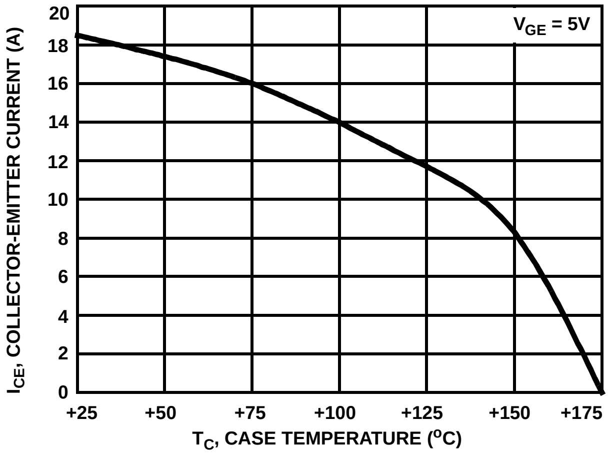


FIGURE 7. COLLECTOR-EMITTER CURRENT AS A FUNCTION OF CASE TEMPERATURE

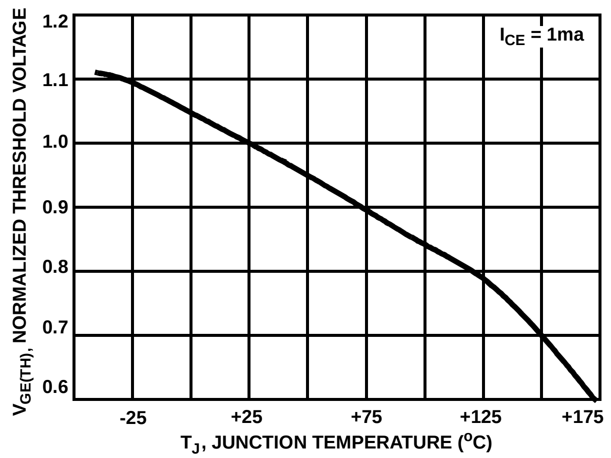


FIGURE 8. NORMALIZED THRESHOLD VOLTAGE AS A FUNCTION OF JUNCTION TEMPERATURE

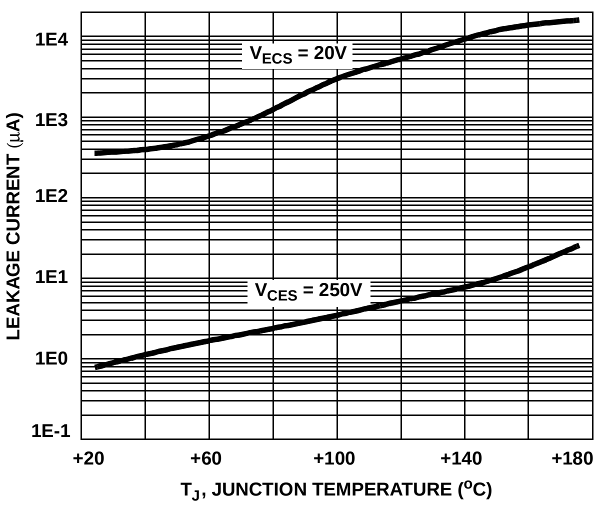


FIGURE 9. LEAKAGE CURRENT AS A FUNCTION OF JUNCTION TEMPERATURE

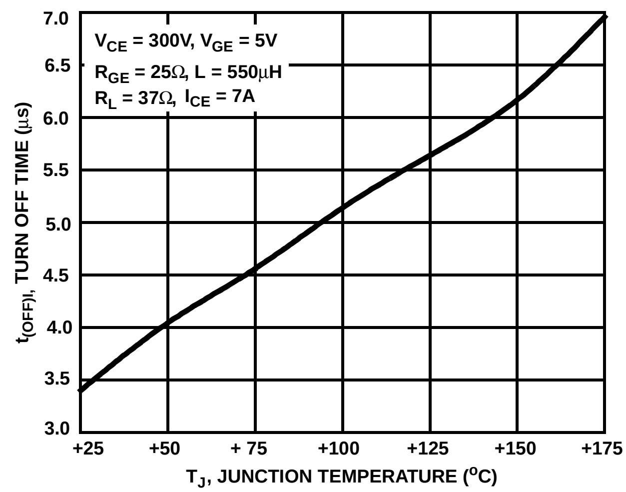


FIGURE 10. TURN-OFF TIME AS A FUNCTION OF JUNCTION TEMPERATURE

Typical Performance Curves (Continued)

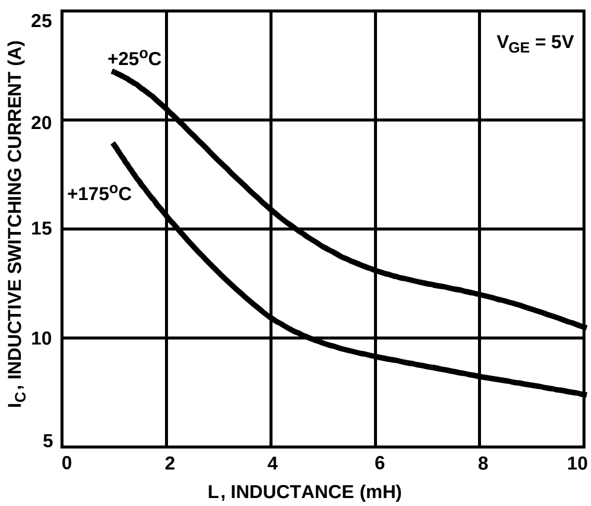


FIGURE 11. SELF CLAMPED INDUCTIVE SWITCHING CURRENT AS A FUNCTION OF INDUCTANCE

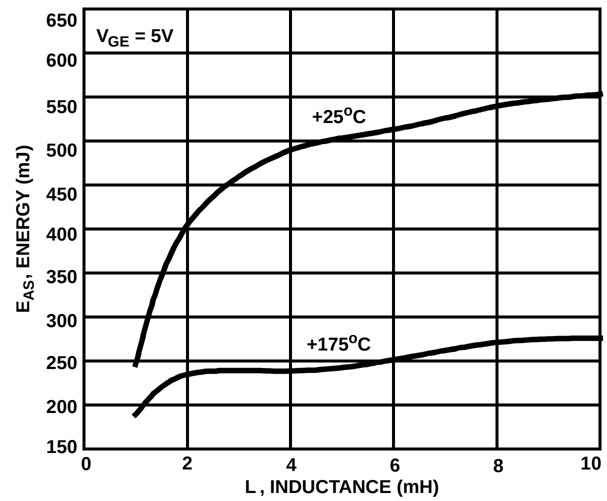


FIGURE 12. SELF CLAMPED INDUCTIVE SWITCHING ENERGY AS A FUNCTION OF INDUCTANCE

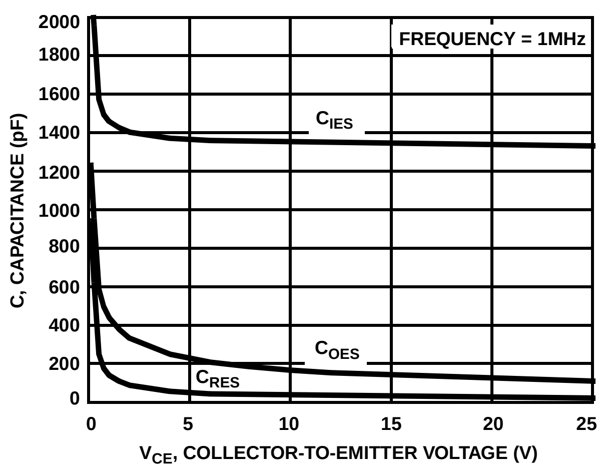


FIGURE 13. CAPACITANCE AS A FUNCTION OF COLLECTOR-EMITTER VOLTAGE

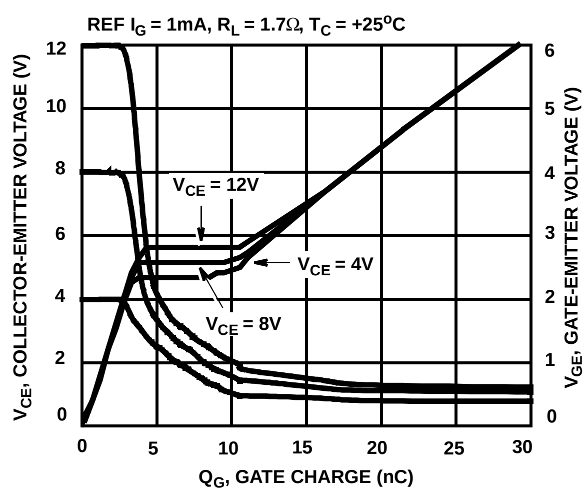


FIGURE 14. GATE CHARGE WAVEFORMS

Typical Performance Curves (Continued)

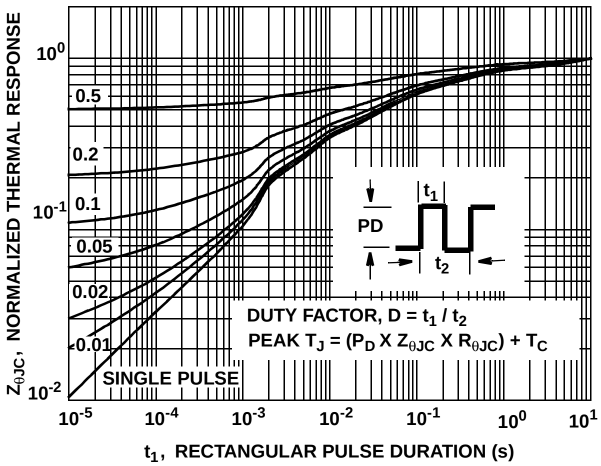


FIGURE 15. NORMALIZED TRANSIENT THERMAL IMPEDANCE, JUNCTION TO CASE

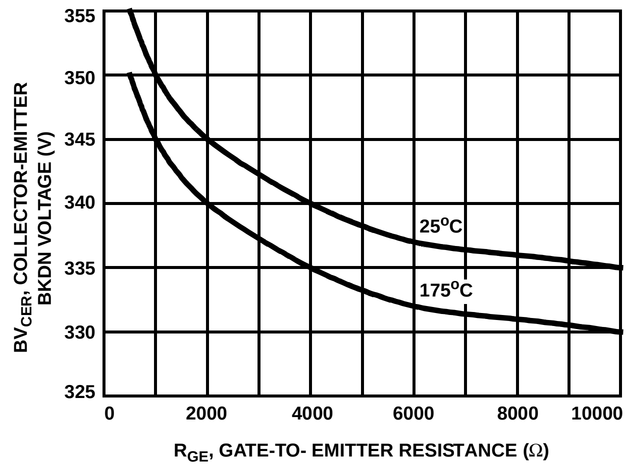


FIGURE 16. BREAKDOWN VOLTAGE AS A FUNCTION OF GATE-EMITTER RESISTANCE

Test Circuits

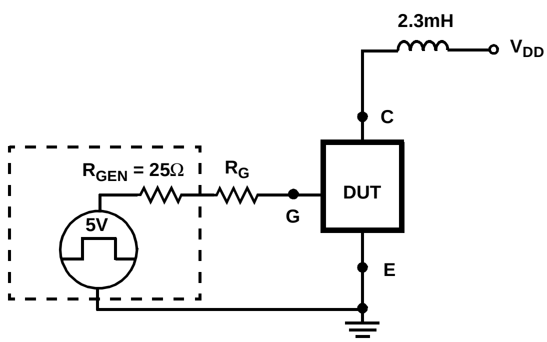


FIGURE 17. SELF CLAMPED INDUCTIVE SWITCHING CURRENT TEST CIRCUIT

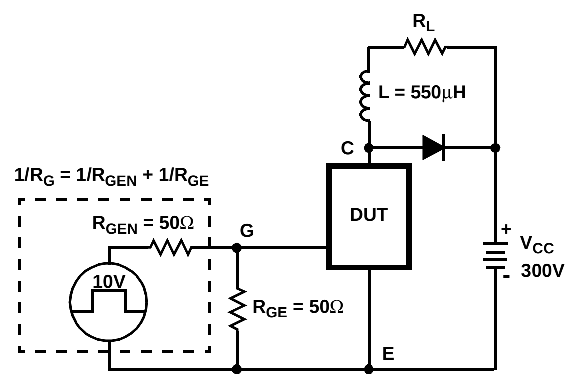


FIGURE 18. CLAMPED INDUCTIVE SWITCHING TIME TEST CIRCUIT

Handling Precautions for IGBT's

Insulated Gate Bipolar Transistors are susceptible to gate-insulation damage by the electrostatic discharge of energy through the devices. When handling these devices, care should be exercised to assure that the static charge built in the handler's body capacitance is not discharged through the device. With proper handling and application procedures, however, IGBT's are currently being extensively used in production by numerous equipment manufacturers in military, industrial and consumer applications, with virtually no damage problems due to electrostatic discharge. IGBT's can be handled safely if the following basic precautions are taken:

1. Prior to assembly into a circuit, all leads should be kept shorted together either by the use of metal shorting springs or by the insertion into conductive material such as †"ECCOSORBD LD26" or equivalent.
2. When devices are removed by hand from their carriers, the hand being used should be grounded by any suitable means - for example, with a metallic wristband.
3. Tips of soldering irons should be grounded.
4. Devices should never be inserted into or removed from circuits with power on.
5. **Gate Voltage Rating** -The gate-voltage rating of V_{GEM} may be exceeded if I_{GEM} is limited to 10mA.

† Trademark Emerson and Cumming, Inc

FAIRCHILD CORPORATION IGBT PRODUCT IS COVERED BY ONE OR MORE OF THE FOLLOWING U.S. PATENTS:

4,364,073	4,417,385	4,430,792	4,443,931	4,466,176	4,516,143	4,532,534	4,567,641
4,587,713	4,598,461	4,605,948	4,618,872	4,620,211	4,631,564	4,639,754	4,639,762
4,641,162	4,644,637	4,682,195	4,684,413	4,694,313	4,717,679	4,743,952	4,783,690
4,794,432	4,801,986	4,803,533	4,809,045	4,809,047	4,810,665	4,823,176	4,837,606
4,860,080	4,883,767	4,888,627	4,890,143	4,901,127	4,904,609	4,933,740	4,963,951
4,969,027							

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. H4

HGT1S14N36G3VLS

14A, 380V Logic Level, Voltage Clamped, Avalanche Energy Rated, ESD Protected IGBT

Contents

BUY

Datasheet
Download this datasheet

e-mail this datasheet

This page
Print version

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- Request samples
- How to order products
- Product Change Notices (PCNs)
- Support
- Sales support
- Quality and reliability
- Design center

General description

This N-Channel IGBT is a MOS gated, logic level device which is intended to be used as an ignition coil driver in auto-motive ignition circuits. Unique features include an active voltage clamp between the collector and the gate which pro-vides Self Clamped Inductive Switching (SCIS) capability in ignition circuits. Internal diodes provide ESD protection for the logic level gate. Both a series resistor and a shunt resister are provided in the gate circuit.

Formerly Developmental Type TA49021.

back to top

Features

- Logic Level Gate Drive
- Internal Voltage Clamp
- ESD Gate Protection
- T_J = 175°C
- Ignition Energy Capable

back to top

Product status/pricing/packaging

BUY

Product	Product status	Pb-free Status	Pricing*	Package type	Leads	Packing method	Package Marking Convention**
HGT1S14N36G3VLS	Full Production	Full Production	$2.58	TO-263(D2PAK)	2	RAIL	Line 1: **$Y** (Fairchild logo) &**Z** (Asm. Plant Code) &**3** (3-Digit Date Code) &**T** (Die Trace Code) Line 2: 14N36GVL
HGT1S14N36G3VLT	Full Production	Full Production	$2.64	TO-263(D2PAK)	2	TAPE REEL	Line 1: **$Y** (Fairchild logo) &**Z** (Asm. Plant Code) &**3** (3-Digit Date Code) &**T** (Die Trace Code) Line 2: 14N36GVL

* Fairchild 1,000 piece Budgetary Pricing
** A sample button will appear if the part is available through Fairchild's on-line samples program. If there is no sample button, please contact a Fairchild distributor to obtain samples

Indicates product with Pb-free second-level interconnect. For more information click here.

Package marking information for product HGT1S14N36G3VLS is available. Click here for more information .

back to top

Qualification Support

Click on a product for detailed qualification data

Product
HGT1S14N36G3VLS
HGT1S14N36G3VLT

back to top